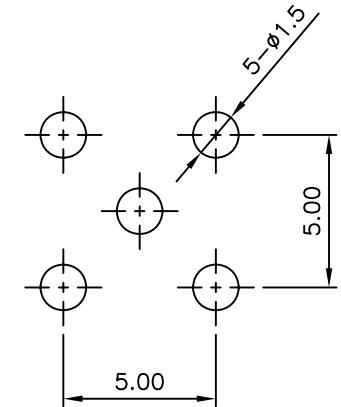
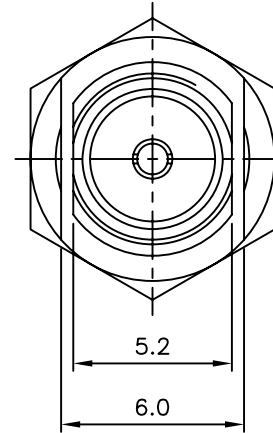
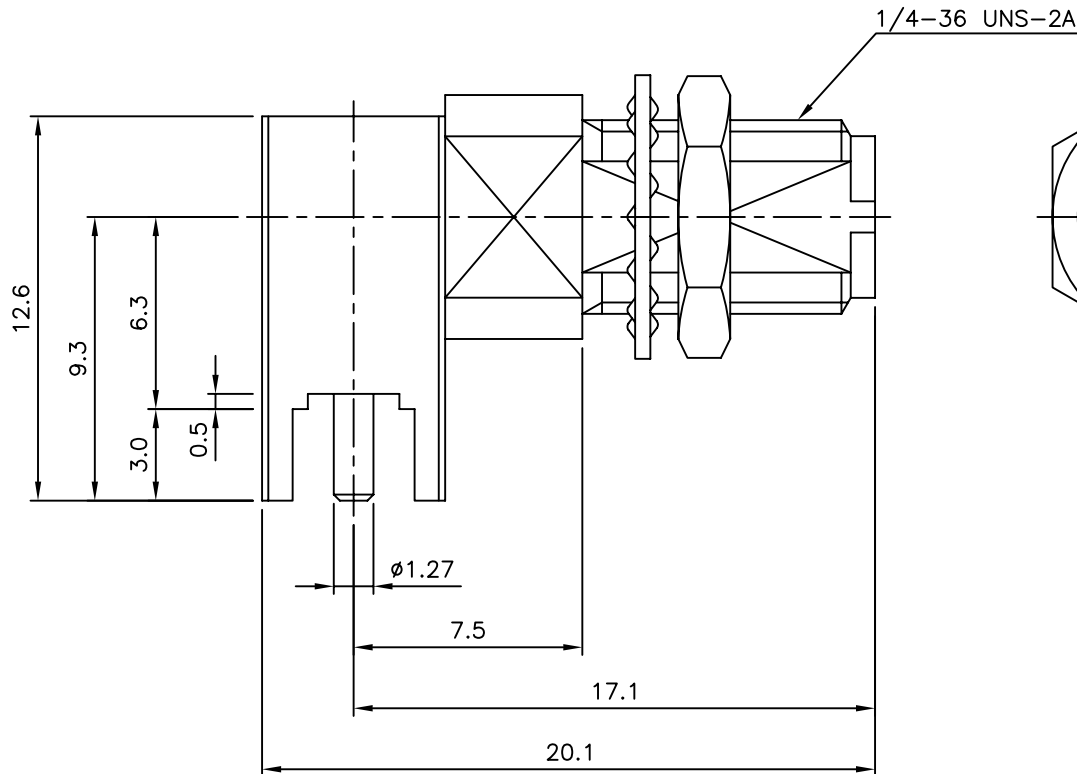
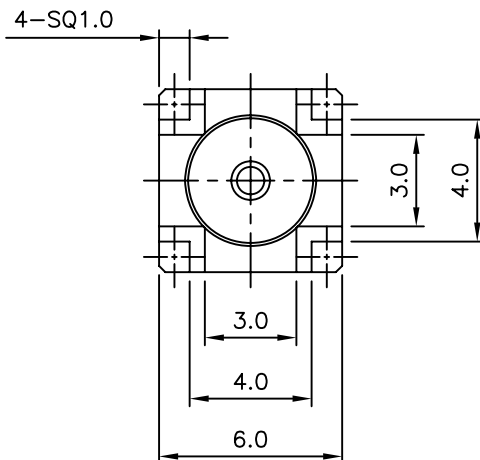


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM	I.C.KIM	2012.08.29.
1	조립JIG 적용으로 인한 DBB 및 후가공 공정 삭제로 바디코드 변경	S.Y.EUN	S.H.KIM	2022.05.31.



PCB MOUNTING HOLE SIZE



8	WASHER	1	BsS	Nickel Plate	DWA00005-5/3
7	NUT	1	MBsBD	Nickel Plate	DNT00025-5/5
6	COVER	1	MBsBD	Nickel Plate	DCO00026-5/1
5	INSULATOR	1	TEFLON		DIN01743-N/1
4	INSULATOR	1	TEFLON		DIN00190-N/1
3	CONTACT	1	MBsBD	Gold Plate	DCT02655-5/1
2	CONTACT	1	BeCu	Gold Plate	DCT02654-5/1
1-2	BODY	1	MBsBD	Nickel Plate (납땜성향상)	DBD03137-5/1 DBD03137-3/1
1-1	BODY	1	MBsBD	Nickel Plate	DBD03320-5/1 DBD03136-5/1 DBD03136-3/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2022. 05. 31.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	S.H.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA50 PCB JLB-4R
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	4/1	A4 DWG NO. CN02847-7/1 REVISION 1 SHEET 1 of 1
		UNIT	mm	